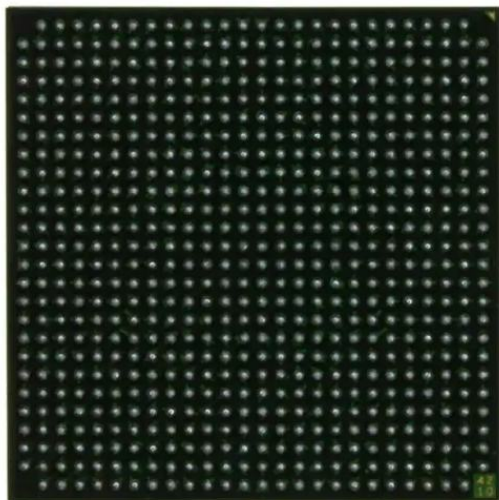




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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	752
Number of Logic Elements/Cells	6768
Total RAM Bits	516096
Number of I/O	348
Number of Gates	-
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	672-BBGA, FCBGA
Supplier Device Package	672-FCBGA (27x27)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc2vp4-6ffg672i

- HyperTransport (LDT) I/O with current driver buffers
 - Built-in DDR input and output registers
- Proprietary high-performance SelectLink technology for communications between Xilinx devices
 - High-bandwidth data path
 - Double Data Rate (DDR) link
 - Web-based HDL generation methodology
- SRAM-Based In-System Configuration
 - Fast SelectMAP™ configuration
 - Triple Data Encryption Standard (DES) security option (bitstream encryption)
 - IEEE 1532 support
 - Partial reconfiguration
 - Unlimited reprogrammability
- Readback capability
- Supported by Xilinx Foundation™ and Alliance Series™ Development Systems
 - Integrated VHDL and Verilog design flows
 - ChipScope™ Integrated Logic Analyzer
- 0.13 μm Nine-Layer Copper Process with 90 nm High-Speed Transistors
- 1.5V (V_{CCINT}) core power supply, dedicated 2.5V V_{CCAUX} auxiliary and V_{CCO} I/O power supplies
- IEEE 1149.1 Compatible Boundary-Scan Logic Support
- Flip-Chip and Wire-Bond Ball Grid Array (BGA) Packages in Standard 1.00 mm Pitch.
- Wire-Bond BGA Devices Available in Pb-Free Packaging (www.xilinx.com/pbfree)
- Each Device 100% Factory Tested

General Description

The Virtex-II Pro and Virtex-II Pro X families contain platform FPGAs for designs that are based on IP cores and customized modules. The family incorporates multi-gigabit transceivers and PowerPC CPU blocks in Virtex-II Pro Series FPGA architecture. It empowers complete solutions for telecommunication, wireless, networking, video, and DSP applications.

The leading-edge 0.13 μm CMOS nine-layer copper process and Virtex-II Pro architecture are optimized for high performance designs in a wide range of densities. Combining a wide variety of flexible features and IP cores, the Virtex-II Pro family enhances programmable logic design capabilities and is a powerful alternative to mask-programmed gate arrays.

Architecture

Array Overview

Virtex-II Pro and Virtex-II Pro X devices are user-programmable gate arrays with various configurable elements and embedded blocks optimized for high-density and high-performance system designs. Virtex-II Pro devices implement the following functionality:

- Embedded high-speed serial transceivers enable data bit rate up to 3.125 Gb/s per channel (RocketIO) or 6.25 Gb/s (RocketIO X).
- Embedded IBM PowerPC 405 RISC processor blocks provide performance up to 400 MHz.
- SelectIO-Ultra blocks provide the interface between package pins and the internal configurable logic. Most popular and leading-edge I/O standards are supported by the programmable IOBs.
- Configurable Logic Blocks (CLBs) provide functional elements for combinatorial and synchronous logic, including basic storage elements. BUFTs (3-state buffers) associated with each CLB element drive dedicated segmentable horizontal routing resources.

- Block SelectRAM+ memory modules provide large 18 Kb storage elements of True Dual-Port RAM.
- Embedded multiplier blocks are 18-bit x 18-bit dedicated multipliers.
- Digital Clock Manager (DCM) blocks provide self-calibrating, fully digital solutions for clock distribution delay compensation, clock multiplication and division, and coarse- and fine-grained clock phase shifting.

A new generation of programmable routing resources called Active Interconnect Technology interconnects all these elements. The general routing matrix (GRM) is an array of routing switches. Each programmable element is tied to a switch matrix, allowing multiple connections to the general routing matrix. The overall programmable interconnection is hierarchical and supports high-speed designs.

All programmable elements, including the routing resources, are controlled by values stored in static memory cells. These values are loaded in the memory cells during configuration and can be reloaded to change the functions of the programmable elements.

Features

This section briefly describes Virtex-II Pro / Virtex-II Pro X features. For more details, refer to [Virtex-II Pro and Virtex-II Pro X Platform FPGAs: Functional Description](#).

RocketIO / RocketIO X MGT Cores

The RocketIO and RocketIO X Multi-Gigabit Transceivers are flexible parallel-to-serial and serial-to-parallel embedded transceiver cores used for high-bandwidth interconnection between buses, backplanes, or other subsystems.

Multiple user instantiations in an FPGA are possible, providing up to 100 Gb/s (RocketIO) or 170 Gb/s (RocketIO X) of full-duplex raw data transfer. Each channel can be operated at a maximum data transfer rate of 3.125 Gb/s (RocketIO) or 6.25 Gb/s (RocketIO X).

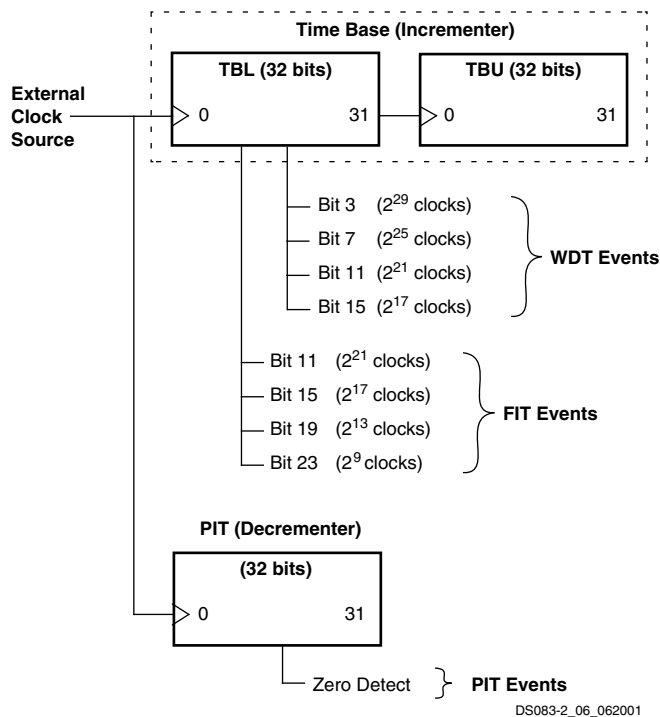


Figure 17: Relationship of Timer Facilities to Base Clock

Interrupts

The PPC405 provides an interface to an interrupt controller that is logically outside the PPC405 core. This controller combines the asynchronous interrupt inputs and presents them to the embedded core as a single interrupt signal. The sources of asynchronous interrupts are external signals, the JTAG/debug unit, and any implemented peripherals.

Debug Logic

All architected resources on the embedded PPC405 core can be accessed through the debug logic. Upon a debug event, the PPC405 core provides debug information to an external debug tool. Three different types of tools are supported depending on the debug mode: ROM monitors, JTAG debuggers, and instruction trace tools.

In internal debug mode, a debug event enables exception-handling software at a dedicated interrupt vector to take

over the CPU core and communicate with a debug tool. The debug tool has read-write access to all registers and can set hardware or software breakpoints. ROM monitors typically use the internal debug mode.

In external debug mode, the CPU core enters stop state (stops instruction execution) when a debug event occurs. This mode offers a debug tool read-write access to all registers in the PPC405 core. Once the CPU core is in stop state, the debug tool can start the CPU core, step an instruction, freeze the timers, or set hardware or software breakpoints. In addition to CPU core control, the debug logic is capable of writing instructions into the instruction cache, eliminating the need for external memory during initial board bring-up. Communication to a debug tool using external debug mode is through the JTAG port.

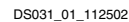
Debug wait mode offers the same functionality as external debug mode with one exception. In debug wait mode, the CPU core goes into wait state instead of stop state after a debug event. Wait state is identical to stop state until an interrupt occurs. In wait state, the PPC405 core can vector to an exception handler, service an interrupt and return to wait state. This mode is particularly useful when debugging real time control systems.

Real-time trace debug mode is always enabled. The debug logic continuously broadcasts instruction trace information to the trace port. When a debug event occurs, the debug logic signals an external debug tool to save instruction trace information before and after the event. The number of instructions traced depends on the trace tool.

Debug events signal the debug logic to stop the CPU core, put the CPU core in debug wait state, cause a debug exception or save instruction trace information.

Big Endian and Little Endian Support

The embedded PPC405 core supports big endian or little endian byte ordering for instructions stored in external memory. Since the PowerPC architecture is big endian internally, the ICU rearranges the instructions stored as little endian into the big endian format. Therefore, the instruction cache always contains instructions in big endian format so that the byte ordering is correct for the execution unit. This feature allows the 405 core to be used in systems designed to function in a little endian environment.



DS083 (v5.0) June 21, 2011
Product Specification

Multiplexers

Virtex-II Pro function generators and associated multiplexers can implement the following:

- 4:1 multiplexer in one slice
- 8:1 multiplexer in two slices
- 16:1 multiplexer in one CLB element (4 slices)
- 32:1 multiplexer in two CLB elements (8 slices)

Each Virtex-II Pro slice has one MUXF5 multiplexer and one MUXFX multiplexer. The MUXFX multiplexer implements the MUXF6, MUXF7, or MUXF8, as shown in **Figure 41**. Each CLB element has two MUXF6 multiplexers, one MUXF7 multiplexer and one MUXF8 multiplexer. Examples of multiplexers are shown in the *Virtex-II Pro Platform FPGA User Guide*. Any LUT can implement a 2:1 multiplexer.

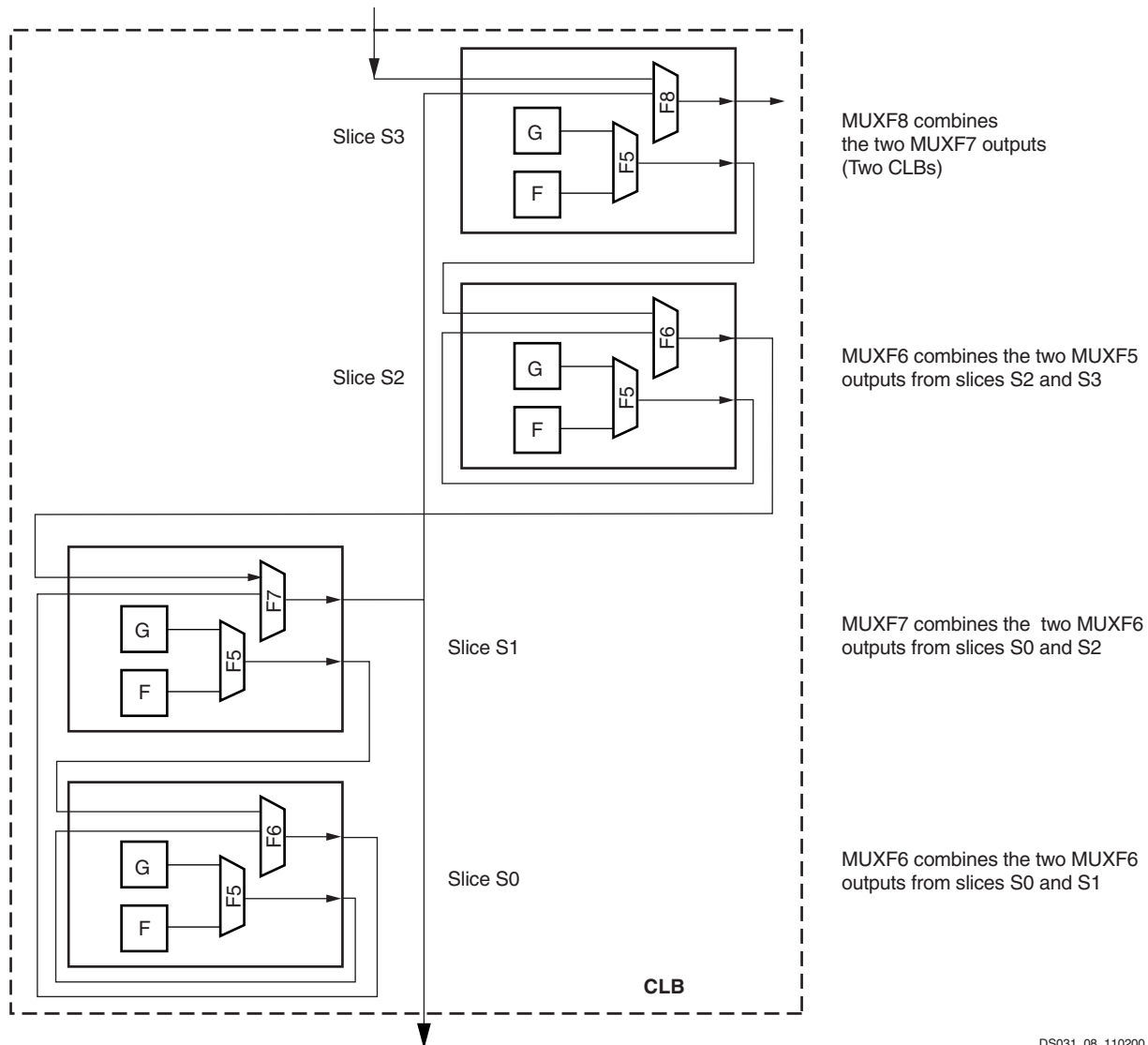


Figure 41: MUXF5 and MUXFX multiplexers

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Fast Lookahead Carry Logic

Dedicated carry logic provides fast arithmetic addition and subtraction. The Virtex-II Pro CLB has two separate carry chains, as shown in the **Figure 42**.

The height of the carry chains is two bits per slice. The carry chain in the Virtex-II Pro device is running upward. The dedicated carry path and carry multiplexer (MUXCY) can also

be used to cascade function generators for implementing wide logic functions.

Arithmetic Logic

The arithmetic logic includes an XOR gate that allows a 2-bit full adder to be implemented within a slice. In addition, a dedicated AND (MULT_AND) gate (shown in **Figure 34**) improves the efficiency of multiplier implementation.

Table 2: Recommended Operating Conditions

Symbol	Description	Grade	Virtex-II Pro X		Virtex-II Pro		Units
			Min	Max	Min	Max	
V_{CCINT}	Internal supply voltage relative to GND, $T_J = 0^\circ\text{C}$ to $+85^\circ\text{C}$	Comm.	1.425	1.575	1.425	1.575	V
	Internal supply voltage relative to GND, $T_J = -40^\circ\text{C}$ to $+100^\circ\text{C}$	Indus.	1.425	1.575	1.425	1.575	V
$V_{CCAUX}^{(1)}$	Auxiliary supply voltage relative to GND, $T_J = 0^\circ\text{C}$ to $+85^\circ\text{C}$	Comm.	2.375	2.625	2.375	2.625	V
	Auxiliary supply voltage relative to GND, $T_J = -40^\circ\text{C}$ to $+100^\circ\text{C}$	Indus.	2.375	2.625	2.375	2.625	V
$V_{CCO}^{(2,3)}$	Supply voltage relative to GND, $T_J = 0^\circ\text{C}$ to $+85^\circ\text{C}$	Comm.	1.2	3.45 ⁽⁵⁾	1.2	3.45 ⁽⁵⁾	V
	Supply voltage relative to GND, $T_J = -40^\circ\text{C}$ to $+100^\circ\text{C}$	Indus.	1.2	3.45 ⁽⁵⁾	1.2	3.45 ⁽⁵⁾	V
V_{IN}	3.3V supply voltage relative to GND, $T_J = 0^\circ\text{C}$ to $+85^\circ\text{C}$	Comm.	GND – 0.2	3.45 ⁽⁵⁾	GND – 0.2	3.45 ⁽⁵⁾	V
	3.3V supply voltage relative to GND, $T_J = -40^\circ\text{C}$ to $+100^\circ\text{C}$	Indus.	GND – 0.2	3.45 ⁽⁵⁾	GND – 0.2	3.45 ⁽⁵⁾	V
	2.5V and below supply voltage relative to GND, $T_J = 0^\circ\text{C}$ to $+85^\circ\text{C}$	Comm.	GND – 0.2	$V_{CCO} + 0.2$	GND – 0.2	$V_{CCO} + 0.2$	V
	2.5V and below supply voltage relative to GND, $T_J = -40^\circ\text{C}$ to $+100^\circ\text{C}$	Indus.	GND – 0.2	$V_{CCO} + 0.2$	GND – 0.2	$V_{CCO} + 0.2$	V
$V_{BATT}^{(4)}$	Battery voltage relative to GND, $T_J = 0^\circ\text{C}$ to $+85^\circ\text{C}$	Comm.	1.0	3.6	1.0	3.6	V
	Battery voltage relative to GND, $T_J = -40^\circ\text{C}$ to $+100^\circ\text{C}$	Indus.	1.0	3.6	1.0	3.6	V
$AVCCAUXRX^{(6)}$	Auxilliary receive supply voltage relative to GNDA	Comm.	1.425 ⁽⁷⁾	1.575 ⁽⁷⁾	2.375	2.625	V
		Indus.	1.425 ⁽⁷⁾	1.575 ⁽⁷⁾	2.375	2.625	V
$AVCCAUTX^{(6)}$	Auxilliary transmit supply voltage relative to GNDA	Comm.	2.375	2.625	2.375	2.625	V
		Indus.	2.375	2.625	2.375	2.625	V
V_{TRX}	Terminal receive supply voltage relative to GND	Comm.	0	2.625	1.6	2.625	V
		Indus.	0	2.625	1.6	2.625	V
V_{TTX}	Terminal transmit supply voltage relative to GND	Comm.	1.425	1.575	1.6	2.625	V
		Indus.	1.425	1.575	1.6	2.625	V

Notes:

1. Recommended maximum voltage droop for V_{CCAUX} is 10 mV/ms.
2. Configuration data is retained even if V_{CCO} drops to 0V.
3. For 3.3V I/O operation, refer to [XAPP659](#), available on the Xilinx website at www.xilinx.com.
4. If battery is not used, connect V_{BATT} to GND or V_{CCAUX} .
5. For PCI and PCI-X, refer to [XAPP653](#), available on the Xilinx website at www.xilinx.com.
6. **IMPORTANT!** The RocketIO transceivers have certain power guidelines that must be met, even if unused in the design. Please refer to the section entitled “Powering the RocketIO Transceivers” in the [RocketIO Transceiver User Guide](#) or [RocketIO X Transceiver User Guide](#) for more details.
7. For non-8B/10B-encoded data, the specification for $AVCCAUXRX$ is $1.8V \pm 5\%$ (1.71 – 1.89V).

Table 35: IOB Input Switching Characteristics (Continued)

			Speed Grade			
Description	Symbol	Device	-7	-6	-5	Units
Setup and Hold Times With Respect to Clock at IOB Input Register						
Pad, no delay	$T_{IOIPICK}/T_{IOICKP}$	All	0.84/−0.61	0.86/−0.63	0.90/−0.67	ns, min
Pad, with delay	$T_{IOIPICKD}/T_{IOICKPD}$	XC2VP2	2.28/−1.89	2.60/−2.15	2.95/−2.43	ns, max
		XC2VP4	2.55/−2.10	2.87/−2.36	3.21/−2.65	ns, max
		XC2VP7	2.48/−2.05	2.82/−2.32	3.15/−2.60	ns, max
		XC2VP20	2.63/−2.05	3.02/−2.35	3.40/−2.66	ns, max
		XC2VPX20	2.63/−2.05	3.02/−2.35	3.40/−2.66	ns, max
		XC2VP30	2.67/−2.07	3.09/−2.42	3.49/−2.73	ns, max
		XC2VP40	3.28/−2.56	3.61/−2.83	4.01/−3.15	ns, max
		XC2VP50	3.84/−3.02	4.08/−3.21	4.42/−3.48	ns, max
		XC2VP70	3.98/−3.13	4.23/−3.33	4.55/−3.58	ns, max
		XC2VPX70	3.98/−3.13	4.23/−3.33	4.55/−3.58	ns, max
	XC2VP100	N/A	6.48/−5.13	7.04/−5.57	ns, max	
ICE input	$T_{IOICECK}/T_{IOCKICE}$	All	0.39/ 0.01	0.44/ 0.01	0.49/ 0.01	ns, min
SR input (IFF, synchronous)	$T_{IOSRCKI}$	All	0.52	0.57	0.75	ns, min
Set/Reset Delays						
SR input to IQ (asynchronous)	T_{IOSRIQ}	All	1.13	1.27	1.42	ns, max
GSR to output IQ	T_{GSRQ}	All	5.87	6.75	7.43	ns, max

Notes:

1. Input timing for LVCMOS25 is measured at 1.25V. For other I/O standards, see [Table 39](#).

Table 5: FG256/FGG256 — XC2VP2 and XC2VP4

Bank	Pin Description	Pin Number
3	IO_L05P_3	L13
3	IO_L03N_3/VREF_3	L12
3	IO_L03P_3	M13
3	IO_L02N_3	M16
3	IO_L02P_3	N16
3	IO_L01N_3/VRP_3	M15
3	IO_L01P_3/VRN_3	M14
4	IO_L01N_4/BUSY/DOUT ⁽¹⁾	P15
4	IO_L01P_4/INIT_B	P14
4	IO_L02N_4/D0/DIN ⁽¹⁾	R14
4	IO_L02P_4/D1	P13
4	IO_L03N_4/D2	T15
4	IO_L03P_4/D3	T14
4	IO_L06N_4/VRP_4	N12
4	IO_L06P_4/VRN_4	P12
4	IO_L07P_4/VREF_4	N11
4	IO_L09N_4	M11
4	IO_L09P_4/VREF_4	M10
4	IO_L69N_4	N10
4	IO_L69P_4/VREF_4	P10
4	IO_L74N_4/GCLK3S	N9
4	IO_L74P_4/GCLK2P	P9
4	IO_L75N_4/GCLK1S	R9
4	IO_L75P_4/GCLK0P	T9
5	IO_L75N_5/GCLK7S	T8
5	IO_L75P_5/GCLK6P	R8
5	IO_L74N_5/GCLK5S	P8
5	IO_L74P_5/GCLK4P	N8
5	IO_L69N_5/VREF_5	P7
5	IO_L69P_5	N7
5	IO_L09N_5/VREF_5	M7
5	IO_L09P_5	M6
5	IO_L07N_5/VREF_5	N6

Table 5: FG256/FGG256 — XC2VP2 and XC2VP4

Bank	Pin Description	Pin Number
5	IO_L06N_5/VRP_5	P5
5	IO_L06P_5/VRN_5	N5
5	IO_L03N_5/D4	T3
5	IO_L03P_5/D5	T2
5	IO_L02N_5/D6	P4
5	IO_L02P_5/D7	R3
5	IO_L01N_5/RDWR_B	P3
5	IO_L01P_5/CS_B	P2
6	IO_L01P_6/VRN_6	M3
6	IO_L01N_6/VRP_6	M2
6	IO_L02P_6	N1
6	IO_L02N_6	M1
6	IO_L03P_6	M4
6	IO_L03N_6/VREF_6	L5
6	IO_L05P_6	L4
6	IO_L05N_6	L3
6	IO_L06P_6	L2
6	IO_L06N_6	L1
6	IO_L85P_6	K4
6	IO_L85N_6	K3
6	IO_L87P_6	K2
6	IO_L87N_6/VREF_6	K1
6	IO_L89P_6	K5
6	IO_L89N_6	J4
6	IO_L90P_6	J3
6	IO_L90N_6	J2
7	IO_L90P_7	J1
7	IO_L90N_7	H1
7	IO_L88P_7	H2
7	IO_L88N_7/VREF_7	H3
7	IO_L86P_7	H4
7	IO_L86N_7	G5
7	IO_L85P_7	G1

Table 6: FG456/FGG456 — XC2VP2, XC2VP4, and XC2VP7

Bank	Pin Description	Pin Number	No Connects		
			XC2VP2	XC2VP4	XC2VP7
1	IO_L07P_1	F14			
1	IO_L06N_1	C15			
1	IO_L06P_1	D15			
1	IO_L05_1/No_Pair	E15			
1	IO_L03N_1/VREF_1	C16			
1	IO_L03P_1	D16			
1	IO_L02N_1	E16			
1	IO_L02P_1	E17			
1	IO_L01N_1/VRP_1	D17			
1	IO_L01P_1/VRN_1	D18			
2	IO_L01N_2/VRP_2	C21			
2	IO_L01P_2/VRN_2	C22			
2	IO_L02N_2	D21			
2	IO_L02P_2	D22			
2	IO_L03N_2	E19			
2	IO_L03P_2	E20			
2	IO_L04N_2/VREF_2	E21			
2	IO_L04P_2	E22			
2	IO_L06N_2	F19			
2	IO_L06P_2	F20			
2	IO_L43N_2	F21	NC		
2	IO_L43P_2	F22	NC		
2	IO_L46N_2/VREF_2	F18	NC		
2	IO_L46P_2	G18	NC		
2	IO_L48N_2	G19	NC		
2	IO_L48P_2	G20	NC		
2	IO_L49N_2	G21	NC		
2	IO_L49P_2	G22	NC		
2	IO_L50N_2	H19	NC		
2	IO_L50P_2	H20	NC		
2	IO_L52N_2/VREF_2	H21	NC		
2	IO_L52P_2	H22	NC		
2	IO_L54N_2	H18	NC		
2	IO_L54P_2	J17	NC		
2	IO_L55N_2	J19	NC		
2	IO_L55P_2	J20	NC		

Table 7: FG676/FGG676 — XC2VP20, XC2VP30, and XC2VP40

Bank	Pin Description	Pin Number	No Connects		
			XC2VP20	XC2VP30	XC2VP40
N/A	VTTXPAD4	B4			
N/A	TXNPAD4	A4			
N/A	TXPPAD4	A5			
N/A	GND4	C6			
N/A	RXPPAD4	A6			
N/A	RXNPAD4	A7			
N/A	VTRXPAD4	B6			
N/A	AVCCAUXRX4	B7			
N/A	AVCCAUXTX6	B10			
N/A	VTTXPAD6	B9			
N/A	TXNPAD6	A9			
N/A	TXPPAD6	A10			
N/A	GND6	C11			
N/A	RXPPAD6	A11			
N/A	RXNPAD6	A12			
N/A	VTRXPAD6	B11			
N/A	AVCCAUXRX6	B12			
N/A	AVCCAUXTX7	B16			
N/A	VTTXPAD7	B15			
N/A	TXNPAD7	A15			
N/A	TXPPAD7	A16			
N/A	GND7	C16			
N/A	RXPPAD7	A17			
N/A	RXNPAD7	A18			
N/A	VTRXPAD7	B17			
N/A	AVCCAUXRX7	B18			
N/A	AVCCAUXTX9	B21			
N/A	VTTXPAD9	B20			
N/A	TXNPAD9	A20			
N/A	TXPPAD9	A21			
N/A	GND9	C21			
N/A	RXPPAD9	A22			
N/A	RXNPAD9	A23			
N/A	VTRXPAD9	B22			
N/A	AVCCAUXRX9	B23			

Table 8: FF672 — XC2VP2, XC2VP4, and XC2VP7

Bank	Pin Description	Pin Number	No Connects		
			XC2VP2	XC2VP4	XC2VP7
6	IO_L52N_6	U22	NC		
6	IO_L53P_6	U23	NC		
6	IO_L53N_6	U24	NC		
6	IO_L54P_6	V26	NC		
6	IO_L54N_6	U26	NC		
6	IO_L55P_6	U20	NC		
6	IO_L55N_6	T19	NC		
6	IO_L56P_6	T20	NC		
6	IO_L56N_6	R20	NC		
6	IO_L57P_6	T21	NC		
6	IO_L57N_6/VREF_6	T22	NC		
6	IO_L58P_6	T23	NC		
6	IO_L58N_6	T24	NC		
6	IO_L59P_6	T25	NC		
6	IO_L59N_6	T26	NC		
6	IO_L60P_6	R19	NC		
6	IO_L60N_6	P19	NC		
6	IO_L85P_6	R21			
6	IO_L85N_6	R22			
6	IO_L86P_6	R23			
6	IO_L86N_6	R24			
6	IO_L87P_6	R25			
6	IO_L87N_6/VREF_6	R26			
6	IO_L88P_6	P20			
6	IO_L88N_6	P21			
6	IO_L89P_6	P22			
6	IO_L89N_6	P23			
6	IO_L90P_6	P24			
6	IO_L90N_6	P25			
7	IO_L90P_7	N25			
7	IO_L90N_7	N24			
7	IO_L89P_7	N23			
7	IO_L89N_7	N22			
7	IO_L88P_7	N21			
7	IO_L88N_7/VREF_7	N20			
7	IO_L87P_7	M26			

Table 9: FF896 — XC2VP7, XC2VP20, XC2VPX20, and XC2VP30

Bank	Pin Description		Pin Number	No Connects		
	Virtex-II Pro devices	XC2VPX20 (if Different)		XC2VP7	XC2VP20, XC2VPX20	XC2VP30
0	IO_L53_0/No_Pair		A21	NC		
0	IO_L54N_0		H18	NC		
0	IO_L54P_0		G18	NC		
0	IO_L56N_0		C21	NC		
0	IO_L56P_0		C20	NC		
0	IO_L57N_0		J17	NC		
0	IO_L57P_0/VREF_0		H17	NC		
0	IO_L67N_0		E17			
0	IO_L67P_0		D17			
0	IO_L68N_0		D18			
0	IO_L68P_0		C18			
0	IO_L69N_0		J16			
0	IO_L69P_0/VREF_0		H16			
0	IO_L73N_0		E16			
0	IO_L73P_0		D16			
0	IO_L74N_0/GCLK7P		C16			
0	IO_L74P_0/GCLK6S		B16			
0	IO_L75N_0/GCLK5P	BREFCLKN	G16			
0	IO_L75P_0/GCLK4S	BREFCLKP	F16			
1	IO_L75N_1/GCLK3P		F15			
1	IO_L75P_1/GCLK2S		G15			
1	IO_L74N_1/GCLK1P		B15			
1	IO_L74P_1/GCLK0S		C15			
1	IO_L73N_1		D15			
1	IO_L73P_1		E15			
1	IO_L69N_1/VREF_1		H15			
1	IO_L69P_1		J15			
1	IO_L68N_1		C13			
1	IO_L68P_1		D13			
1	IO_L67N_1		D14			
1	IO_L67P_1		E14			
1	IO_L57N_1/VREF_1		H14	NC		
1	IO_L57P_1		J14	NC		
1	IO_L56N_1		C11	NC		
1	IO_L56P_1		C10	NC		

Table 9: FF896 — XC2VP7, XC2VP20, XC2VPX20, and XC2VP30

Bank	Pin Description		Pin Number	No Connects		
	Virtex-II Pro devices	XC2VPX20 (if Different)		XC2VP7	XC2VP20, XC2VPX20	XC2VP30
6	IO_L44P_6		AA25			
6	IO_L44N_6		AA26			
6	IO_L45P_6		AC29			
6	IO_L45N_6/VREF_6		AB29			
6	IO_L46P_6		AB27			
6	IO_L46N_6		AB28			
6	IO_L47P_6		W23			
6	IO_L47N_6		W24			
6	IO_L48P_6		AA27			
6	IO_L48N_6		AA28			
6	IO_L49P_6		Y26			
6	IO_L49N_6		Y27			
6	IO_L50P_6		W25			
6	IO_L50N_6		W26			
6	IO_L51P_6		AB30			
6	IO_L51N_6/VREF_6		AA30			
6	IO_L52P_6		W27			
6	IO_L52N_6		W28			
6	IO_L53P_6		V23			
6	IO_L53N_6		V24			
6	IO_L54P_6		AA29			
6	IO_L54N_6		Y29			
6	IO_L55P_6		V25			
6	IO_L55N_6		V26			
6	IO_L56P_6		U23			
6	IO_L56N_6		U24			
6	IO_L57P_6		Y30			
6	IO_L57N_6/VREF_6		W30			
6	IO_L58P_6		V27			
6	IO_L58N_6		V28			
6	IO_L59P_6		U22			
6	IO_L59N_6		T22			
6	IO_L60P_6		W29			
6	IO_L60N_6		V29			
6	IO_L85P_6		U26			
6	IO_L85N_6		U27			

Table 10: FF1152 — XC2VP20, XC2VP30, XC2VP40, and XC2VP50

Bank	Pin Description	Pin Number	No Connects			
			XC2VP20	XC2VP30	XC2VP40	XC2VP50
7	IO_L43N_7	M31				
7	IO_L42P_7	L32				
7	IO_L42N_7	L31				
7	IO_L41P_7	N28				
7	IO_L41N_7	N27				
7	IO_L40P_7	M33				
7	IO_L40N_7/VREF_7	L33				
7	IO_L39P_7	M29				
7	IO_L39N_7	M28				
7	IO_L38P_7	N26				
7	IO_L38N_7	N25				
7	IO_L37P_7	L34				
7	IO_L37N_7	K34				
7	IO_L36P_7	L30				
7	IO_L36N_7	L29				
7	IO_L35P_7	L28				
7	IO_L35N_7	L27				
7	IO_L34P_7	K33				
7	IO_L34N_7/VREF_7	J33				
7	IO_L33P_7	K31				
7	IO_L33N_7	K30				
7	IO_L32P_7	M26				
7	IO_L32N_7	M25				
7	IO_L31P_7	H34				
7	IO_L31N_7	H33				
7	IO_L24P_7	H32	NC			
7	IO_L24N_7	H31	NC			
7	IO_L23P_7	K28	NC			
7	IO_L23N_7	K27	NC			
7	IO_L22P_7	J32	NC			
7	IO_L22N_7/VREF_7	J31	NC			
7	IO_L21P_7	J30	NC			
7	IO_L21N_7	J29	NC			
7	IO_L20P_7	G34	NC			
7	IO_L20N_7	G33	NC			
7	IO_L19P_7	H30	NC			
7	IO_L19N_7	H29	NC			
7	IO_L18P_7	L26	NC			

Table 10: FF1152 — XC2VP20, XC2VP30, XC2VP40, and XC2VP50

Bank	Pin Description	Pin Number	No Connects			
			XC2VP20	XC2VP30	XC2VP40	XC2VP50
7	VCCO_7	T23				
7	VCCO_7	U23				
N/A	CCLK	AE9				
N/A	PROG_B	J26				
N/A	DONE	AE10				
N/A	M0	AF26				
N/A	M1	AE26				
N/A	M2	AE25				
N/A	TCK	J9				
N/A	TDI	H28				
N/A	TDO	H7				
N/A	TMS	K10				
N/A	PWRDWN_B	AF9				
N/A	HSWAP_EN	K25				
N/A	RSVD	G8				
N/A	VBATT	K9				
N/A	DXP	K26				
N/A	DXN	G27				
N/A	AVCCAUXTX2	B32	NC	NC		
N/A	VTTXPAD2	B33	NC	NC		
N/A	TXNPAD2	A33	NC	NC		
N/A	TXPPAD2	A32	NC	NC		
N/A	GND A2	C30	NC	NC		
N/A	RXPPAD2	A31	NC	NC		
N/A	RXNPAD2	A30	NC	NC		
N/A	VTRXPAD2	B31	NC	NC		
N/A	AVCCAUXRX2	B30	NC	NC		
N/A	AVCCAUXTX4	B28				
N/A	VTTXPAD4	B29				
N/A	TXNPAD4	A29				
N/A	TXPPAD4	A28				
N/A	GND A4	C27				
N/A	RXPPAD4	A27				
N/A	RXNPAD4	A26				
N/A	VTRXPAD4	B27				
N/A	AVCCAUXRX4	B26				
N/A	AVCCAUXTX5	B24	NC	NC	NC	

Table 11: FF1148 — XC2VP40 and XC2VP50

Bank	Pin Description	Pin Number	No Connects	
			XC2VP40	XC2VP50
N/A	GND	AF30		
N/A	GND	AB30		
N/A	GND	W30		
N/A	GND	T30		
N/A	GND	N30		
N/A	GND	J30		
N/A	GND	E30		
N/A	GND	A30		
N/A	GND	AP26		
N/A	GND	AK26		
N/A	GND	AB26		
N/A	GND	W26		
N/A	GND	T26		
N/A	GND	N26		
N/A	GND	E26		
N/A	GND	A26		
N/A	GND	AE25		
N/A	GND	K25		
N/A	GND	AP22		
N/A	GND	AK22		
N/A	GND	AF22		
N/A	GND	J22		
N/A	GND	E22		
N/A	GND	A22		
N/A	GND	Y21		
N/A	GND	W21		
N/A	GND	V21		
N/A	GND	U21		
N/A	GND	T21		
N/A	GND	R21		
N/A	GND	AA20		
N/A	GND	Y20		
N/A	GND	W20		
N/A	GND	V20		
N/A	GND	U20		
N/A	GND	T20		
N/A	GND	R20		
N/A	GND	P20		

Table 11: FF1148 — XC2VP40 and XC2VP50

Bank	Pin Description	Pin Number	No Connects	
			XC2VP40	XC2VP50
N/A	GND	AP19		
N/A	GND	AK19		
N/A	GND	AF19		
N/A	GND	AA19		
N/A	GND	Y19		
N/A	GND	W19		
N/A	GND	V19		
N/A	GND	U19		
N/A	GND	T19		
N/A	GND	R19		
N/A	GND	P19		
N/A	GND	J19		
N/A	GND	E19		
N/A	GND	A19		
N/A	GND	AP18		
N/A	GND	AA18		
N/A	GND	Y18		
N/A	GND	W18		
N/A	GND	V18		
N/A	GND	U18		
N/A	GND	T18		
N/A	GND	R18		
N/A	GND	P18		
N/A	GND	A18		
N/A	GND	AA17		
N/A	GND	Y17		
N/A	GND	W17		
N/A	GND	V17		
N/A	GND	U17		
N/A	GND	T17		
N/A	GND	R17		
N/A	GND	P17		
N/A	GND	AP16		
N/A	GND	AK16		
N/A	GND	AF16		
N/A	GND	AA16		
N/A	GND	Y16		
N/A	GND	W16		

Table 11: FF1148 — XC2VP40 and XC2VP50

Bank	Pin Description	Pin Number	No Connects	
			XC2VP40	XC2VP50
N/A	GND	AP5		
N/A	GND	AK5		
N/A	GND	AF5		
N/A	GND	AB5		
N/A	GND	W5		
N/A	GND	T5		
N/A	GND	N5		
N/A	GND	J5		
N/A	GND	E5		
N/A	GND	A5		
N/A	GND	AM3		
N/A	GND	C3		
N/A	GND	AN2		
N/A	GND	B2		
N/A	GND	AK1		
N/A	GND	AF1		
N/A	GND	AB1		
N/A	GND	W1		
N/A	GND	V1		
N/A	GND	T1		
N/A	GND	N1		
N/A	GND	J1		
N/A	GND	E1		

Notes:

1. See [Table 4](#) for an explanation of the signals available on this pin.

Table 12: FF1517 — XC2VP50 and XC2VP70

Bank	Pin Description	Pin Number	No Connects	
			XC2VP50	XC2VP70
3	IO_L47P_3	AC10		
3	IO_L46N_3	AE7		
3	IO_L46P_3	AE8		
3	IO_L45N_3/VREF_3	AE5		
3	IO_L45P_3	AE6		
3	IO_L44N_3	AB13		
3	IO_L44P_3	AC13		
3	IO_L43N_3	AE3		
3	IO_L43P_3	AE4		
3	IO_L42N_3	AE1		
3	IO_L42P_3	AE2		
3	IO_L41N_3	AD10		
3	IO_L41P_3	AD11		
3	IO_L40N_3	AF6		
3	IO_L40P_3	AF7		
3	IO_L39N_3/VREF_3	AF4		
3	IO_L39P_3	AF5		
3	IO_L38N_3	AC12		
3	IO_L38P_3	AD12		
3	IO_L37N_3	AF1		
3	IO_L37P_3	AF2		
3	IO_L36N_3	AG6		
3	IO_L36P_3	AG7		
3	IO_L35N_3	AE9		
3	IO_L35P_3	AE10		
3	IO_L34N_3	AF3		
3	IO_L34P_3	AG3		
3	IO_L33N_3/VREF_3	AG1		
3	IO_L33P_3	AG2		
3	IO_L32N_3	AE11		
3	IO_L32P_3	AE12		
3	IO_L31N_3	AH6		
3	IO_L31P_3	AH7		
3	IO_L30N_3	AG5		
3	IO_L30P_3	AH4		
3	IO_L29N_3	AD13		
3	IO_L29P_3	AE13		
3	IO_L28N_3	AH2		

Table 12: FF1517 — XC2VP50 and XC2VP70

Bank	Pin Description	Pin Number	No Connects	
			XC2VP50	XC2VP70
6	IO_L34P_6	AG37		
6	IO_L34N_6	AF37		
6	IO_L35P_6	AE30		
6	IO_L35N_6	AE31		
6	IO_L36P_6	AG33		
6	IO_L36N_6	AG34		
6	IO_L37P_6	AF38		
6	IO_L37N_6	AF39		
6	IO_L38P_6	AD28		
6	IO_L38N_6	AC28		
6	IO_L39P_6	AF35		
6	IO_L39N_6/VREF_6	AF36		
6	IO_L40P_6	AF33		
6	IO_L40N_6	AF34		
6	IO_L41P_6	AD29		
6	IO_L41N_6	AD30		
6	IO_L42P_6	AE38		
6	IO_L42N_6	AE39		
6	IO_L43P_6	AE36		
6	IO_L43N_6	AE37		
6	IO_L44P_6	AC27		
6	IO_L44N_6	AB27		
6	IO_L45P_6	AE34		
6	IO_L45N_6/VREF_6	AE35		
6	IO_L46P_6	AE32		
6	IO_L46N_6	AE33		
6	IO_L47P_6	AC30		
6	IO_L47N_6	AC31		
6	IO_L48P_6	AD37		
6	IO_L48N_6	AD38		
6	IO_L49P_6	AD33		
6	IO_L49N_6	AD34		
6	IO_L50P_6	AB28		
6	IO_L50N_6	AB29		
6	IO_L51P_6	AD36		
6	IO_L51N_6/VREF_6	AC36		
6	IO_L52P_6	AD32		
6	IO_L52N_6	AC32		